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APPLICATION NO.	ICATION NO. FILING DATE FIRST NAMED INVENTO		ATTORNEY DOCKET NO.	O. CONFIRMATION NO.		
10/604,190	06/30/2003	Bruce B. Doris	FIS920030152	1189		
32074	7590 06/16/2005		EXAM	EXAMINER		
INTERNAT	ΓΙΟΝΑL BUSINESS Μ.	TRAN, MAI HUONG C				
DEPT. 18G	400	ART UNIT	DARED MILAGED			
BLDG. 300-	· • =	ARTUNII	PAPER NUMBER			
2070 ROUT	E 52	2818				
HOPEWELL JUNCTION, NY 12533			DATE MAILED: 06/16/2005			

Please find below and/or attached an Office communication concerning this application or proceeding.

		Amuliantia	- N-	Applicant(s)				
Office Action Summary		Application						
		10/604,19	0	DORIS ET AL.				
	Office Action Summary	Examiner		Art Unit				
	The MAN INO DATE of this communi	Mai-Huong		2818	Idroca			
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply								
THE after - If the - If NO - Failu	ORTENED STATUTORY PERIOD FOMAILING DATE OF THIS COMMUNION IN INSIGN SOLUTION OF THIS COMMUNION IN INTERPOLATION OF THIS COMMUNION OF THE PROPERTY OF THE PROPERTY OF THIS COMMUNION OF THE PROPERTY OF THIS COMMUNION OF THE PROPERTY OF THIS COMMUNICATION OF THIS COMM	CATION. of 37 CFR 1.136(a). In no eve unication. )) days, a reply within the statu tutory period will apply and wil will. by statute. cause the appl	nt, however, may a reply be tim tory minimum of thirty (30) days I expire SIX (6) MONTHS from cation to become ABANDONEI	nely filed s will be considered timel the mailing date of this c D (35 U.S.C. § 133).	y. ommunication.			
Status								
1)⊠	Responsive to communication(s) file	d on <u>3/28/05</u> .						
2a) This action is <b>FINAL</b> . 2b) This action is non-final.								
3)□	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.							
Disposition of Claims								
. 5)□ 6)⊠ 7)□	Claim(s) 1-17,21 and 22 is/are pending in the application.  4a) Of the above claim(s) is/are withdrawn from consideration.  Claim(s) is/are allowed.  Claim(s) 1-17,21 and 22 is/are rejected.  Claim(s) is/are objected to.  Claim(s) are subject to restriction and/or election requirement.							
Applicat	ion Papers							
10)⊠	The specification is objected to by the The drawing(s) filed on 30 June 2003 Applicant may not request that any object Replacement drawing sheet(s) including The oath or declaration is objected to	$B$ is/are: a) $\square$ accepted action to the drawing(s) be the correction is require	e held in abeyance. See ed if the drawing(s) is ob	e 37 CFR 1.85(a). jected to. See 37 C				
Priority (	under 35 U.S.C. § 119							
<ul> <li>12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).</li> <li>a) All b) Some * c) None of:</li> <li>1. Certified copies of the priority documents have been received.</li> <li>2. Certified copies of the priority documents have been received in Application No</li> <li>3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).</li> <li>* See the attached detailed Office action for a list of the certified copies not received.</li> </ul>								
2) Notice 3) Infor	te of References Cited (PTO-892) the of Draftsperson's Patent Drawing Review (Pomation Disclosure Statement(s) (PTO-1449 or the No(s)/Mail Date 3/28/05.		4) Interview Summary Paper No(s)/Mail D 5) Notice of Informal F 6) Other:		O-152)			

#### **DETAILED ACTION**

## **Double Patenting**

The nonstatutory double patenting rejection is based on a judicially created doctrine grounded in public policy (a policy reflected in the statute) so as to prevent the unjustified or improper timewise extension of the "right to exclude" granted by a patent and to prevent possible harassment by multiple assignees. See *In re Goodman*, 11 F.3d 1046, 29 USPQ2d 2010 (Fed. Cir. 1993); *In re Longi*, 759 F.2d 887, 225 USPQ 645 (Fed. Cir. 1985); *In re Van Ornum*, 686 F.2d 937, 214 USPQ 761 (CCPA 1982); *In re Vogel*, 422 F.2d 438, 164 USPQ 619 (CCPA 1970); and, *In re Thorington*, 418 F.2d 528, 163 USPQ 644 (CCPA 1969).

A timely filed terminal disclaimer in compliance with 37 CFR 1.321(c) may be used to overcome an actual or provisional rejection based on a nonstatutory double patenting ground provided the conflicting application or patent is shown to be commonly owned with this application. See 37 CFR 1.130(b).

Effective January 1, 1994, a registered attorney or agent of record may sign a terminal disclaimer. A terminal disclaimer signed by the assignee must fully comply with 37 CFR 3.73(b).

Claims 1–17, and 21-22 are rejected under the judicially created doctrine of obviousness-type double patenting as being unpatentable over claims 1-8 of U.S. Patent No. 6,806584. Although the conflicting claims are not identical, they are not patentably

distinct from each other because the subject matter claimed in the instant application is fully disclosed in the patent and is covered by the patent since the patent and the application are claiming common subject matter, as follows: Semiconductor Device Structure Including Multiple FETs Having Different Spacer Widths.

## Claim Rejections - 35 U.S.C. § 103

Claim 1-17 and 21-22 are rejected under 35 U.S.C. 103(a) as being obvious over U.S. Patent No. 6,806,584 to Fung et al. in view of Chidambarrao et al. (6,825,529).

The applied references have a common assignee with the instant application.

Based upon the earlier effective U.S. filing date of the reference, it constitutes prior art only under 35 U.S.C. 102(e). This rejection under 35 U.S.C. 103(a) might be overcome by: (1) a showing under 37 CFR 1.132 that any invention disclosed but not claimed in the reference was derived from the inventor of this application and is thus not an invention "by another"; (2) a showing of a date of invention for the claimed subject matter of the application which corresponds to subject matter disclosed but not claimed in the reference, prior to the effective U.S. filing date of the reference under 37 CFR 1.131; or (3) an oath or declaration under 37 CFR 1.130 stating that the application and reference are currently owned by the same party and that the inventor named in the application is the prior inventor under 35 U.S.C. 104, together with a terminal disclaimer in accordance with 37 CFR 1.321(c). This rejection might also be overcome by showing that the

reference is disqualified under 35 U.S.C. 103(c) as prior art in a rejection under 35 U.S.C. 103(a). See MPEP § 706.02(l)(1) and § 706.02(l)(2).

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which the subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Regarding to claim 1, Fung discloses a semiconductor device structure, comprising at least first and second field effect transistors 100, 110 disposed on a substrate 10; the first field effect transistor 100 including a first spacer 120 having a first width W1; the second field effect transistor 110 including a second spacer 130 having a second width W2 (col. 2, lines 55-60, fig. 1).

Fung does not disclose the second spacer includes a first compressive stress material, and the structure further comprises a tensile stress material disposed on the at least first and second field effect transistors. Chidambarrao teaches the spacer includes a first compressive stress material, and the structure further comprises a tensile stress material disposed on the at least first and second field effect transistors (col. 2, lines 27-53).

It would have been obvious to one of ordinary skill in the art at the time the invention was made to form the spacer that includes a first compressive stress material,

Art Unit: 2818

and the structure further comprises a tensile stress material disposed on the at least first and second field effect transistors, as taught by Chidambarrao in order to provide device performance improvement (col. 2, lines 54-55).

Regarding to claim 2, Fung discloses the structure wherein the first field effect transistor is an nFET and the second field effect transistor is a pFET (col. 2, lines 63-66, fig. 2).

Regarding to claim 3, Fung discloses the structure wherein the first width is less than the second width (col. 2, lines 59-60).

Regarding to claim 4, Fung discloses the structure wherein the structure is an inverter (fig. 3a).

Regarding to claim 5, Fung discloses the structure wherein the structure includes a width transition region located approximately in a middle region between the transistors (fig. 1).

Regarding to claim 6, Fung discloses the structure wherein the first spacer includes an I-shaped part and the second spacer includes an L-shaped part (fig. 13).

Application/Control Number: 10/604,190

Art Unit: 2818

Regarding to claim 7, Fung in view of Chidambarrao discloses the structure wherein the second spacer includes an L-shaped part and the first compressive stress material (Fung: fig. 13, Chidambarrai: col. 2, lines 27-30).

Regarding to claim 8, Chidambarrai discloses the structure, wherein the first spacer includes the first compressive stress material (col. 2, lines 27-30).

Regarding to claim 9, Fung discloses the structure wherein the first width is a substantially uniform width in a range of about 10 nm to about 30 nm, and the second width has a maximum width in a range of about 50 nm to about 120 nm (col. 4, lines 39-43).

Regarding to claim 10, Fung in view of Chidambarrai discloses the claimed invention except for the structure wherein the first compressive stress material has a substantially uniform stress in a range of about -3E9 dynes/cm.sup.2 to about -3E11 dynes/cm.sup.2.

It would have been obvious to one of ordinary skill in the art at the time the invention was made to form the structure wherein the first compressive stress material has a substantially uniform stress in a range of about -3E9 dynes/cm.sup.2 to about -3E11 dynes/cm.sup.2., since it has been held that where the general conditions of a

claim are disclosed in the prior art, discovering the optimum or working ranges involves only routine skill in the art. In re Aller, 105 USPQ 233.

Regarding to claim 11, Fung in view of Chidambarrao discloses the claimed invention except for the structure wherein the tensile stress material has a substantially uniform film thickness in a range of about 20 nm to about 100 nm and a substantially uniform stress in a range of approximately 4E9 dynes/cm.sup.2 to approximately 4E11 dynes/cm.sup.2.

It would have been obvious to one of ordinary skill in the art at the time the invention was made to form the tensile stress material has a substantially uniform film thickness in a range of about 20 nm to about 100 nm and a substantially uniform stress in a range of approximately 4E9 dynes/cm.sup.2 to approximately 4E11 dynes/cm.sup.2, since it has been held that where the general conditions of a claim are disclosed in the prior art, discovering the optimum or working ranges involves only routine skill in the art. In re Aller, 105 USPQ 233.

Regarding to claim 12, Fung in view of Chidambarrao discloses the claimed invention except for the structure wherein the second spacer includes a second compressive stress material having a stress in a range of approximately -2E9 dynes/cm.sup.2 to approximately 2E9 dynes/cm.sup.2.

It would have been obvious to one of ordinary skill in the art at the time the invention was made to form the structure wherein the second spacer includes a second compressive stress material having a stress in a range of approximately -2E9 dynes/cm.sup.2 to approximately 2E9 dynes/cm.sup.2., since it has been held that where the general conditions of a claim are disclosed in the prior art, discovering the optimum or working ranges involves only routine skill in the art. In re Aller, 105 USPQ 233.

Page 8

Regarding to claim 13, Fung discloses the structure wherein the first compressive stress material is a dielectric (col. 3, lines 50).

Regarding to claim 14, Chidambarrao discloses the structure, wherein the first compressive stress material is silicon nitride (col. 4, lines 65).

Regarding to claim 15, Chidambarrao discloses the structure, wherein the tensile stress material is SiN (col. 5, lines 2-3).

Regarding to claim 16, Fung discloses the structure wherein the first width is about 50 nm, and the second width has a maximum width of about 90 nm (col. 4, lines 39-50).

Regarding to claim 17, Fung in view of Chidambarrao discloses the claimed invention except for the structure wherein the tensile stress material is a layer having a substantially uniform thickness in a range of about 20 nm to about 100 nm.

It would have been obvious to one of ordinary skill in the art at the time the invention was made to form the tensile stress material is a layer having a substantially uniform thickness in a range of about 20 nm to about 100 nm, since it has been held that where the general conditions of a claim are disclosed in the prior art, discovering the optimum or working ranges involves only routine skill in the art. In re Aller, 105 USPQ 233.

Regarding to claim 21, Fung discloses the structure wherein the substrate is a silicon substrate (col. 2, line 58).

Regarding to claim 22, Fung discloses the structure wherein the substrate comprises GaAs (col. 2, line 61).

#### Conclusion

Any inquiry concerning this communication on earlier communications from the examiner should be directed to Mai-Huong Tran, (571) 272-1796. The examiner can normally be reached on Monday-Thursday from 8:00 AM to 6:30 PM. The examiner's supervisor, David Nelms can be reached on (571) 272-1787.

Art Unit: 2818

The fax phone number for the organization where this application or proceeding is assigned is (703) 872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR, Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <a href="http://pair-direct.uspto.gov">http://pair-direct.uspto.gov</a>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Mai-Huong Tran